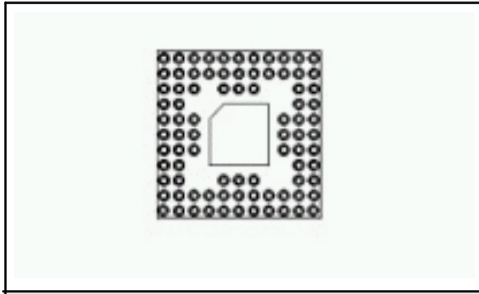


**Product Details for 210705 -4**



**210705 -4**

[Active](#)

**PGA Sockets**

[Not Reviewed for ELV/RoHS Compliance](#)

**Product Highlights:**

- ? Very Low Insertion Force
- ? Number of Positions = 85
- ? PCB Mount Style = Thru Hole
- ? Grid Size = 11x11
- ? Grid Spacing = Standard: 2.54 x 2.54 mm

[View all Features](#)

**Quick Links**

- [Check Pricing & Availability](#)
- [Search for Tooling Product Feature Selector](#)
- [Contact Us About This Product](#)

**Documentation & Additional Information**

**Product Drawings:**

- ? [OPEN FRAME PGA 11x11, 85 SOCKETS](#) (PDF, English)

**Catalog Pages/Data Sheets:**

- ? None Available

**Product Specifications:**

- ? None Available

**Application Specifications:**

- ? None Available

**Instruction Sheets:**

- ? None Available

**CAD Files:**

- ? None Available

**Additional Information:**

- ? [Product Line Information](#)

**Related Products:**

- ? [Tooling](#)

[List all Documents](#)

**Product Features** (Please use the Product Drawing for all design activity)

**Product Type Features:**

- ? [Insertion Force](#) = Very Low
- ? [Number of Positions](#) = 85
- ? PCB Mount Style = Thru Hole
- ? [Grid Size](#) = 11x11
- ? [Grid Spacing \(mm \[in\]\)](#) = Standard: 2.54 x 2.54 [0.100 x 0.100]
- ? [Chip Compatibility](#) = Other
- ? [Frame Style](#) = Open
- ? Sleeve Material = Brass
- ? [Heat Sink Attachment](#) = Without
- ? [Profile](#) = Standard

**Termination Related Features:**

- ? [Termination Post Length \(mm \[in\]\)](#) = 2.83 [0.111]
- ? Socket Identifier = None

**Body Related Features:**

- ? Pick and Place Cover = None

**Contact Related Features:**

- ? [Contact Style](#) = Stamped + Formed
- ? [Contact Material](#) = Beryllium Copper
- ? Contact Mating Area Plating = Gold (30) 24c
- ? Contact Termination Area Plating = Tin Lead over Nickel

**Housing Related Features:**

- ? Housing Material = Glass - Filled Thermoplastic Polyester
- ? Housing Flammability Rating = UL 94V -0
- ? Housing Material Temperature = High

**Industry Standards:**

- ? [RoHS/ELV Compliance](#) = Not reviewed for ELV/RoHS compliance
- ? [Lead Free Solder Processes](#) = Not reviewed for lead free solder process

**Operation/Application:**

- ? [Application](#) = Production

**Packaging Related Features:**

- ? Packaging Method = Tube

**Other:**

- ? Brand = AMP